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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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MOS FIELD EFFECT TRANSISTOR μ PA2450

N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

DESCRIPTION

The μ PA2450 is a switching device which can be driven directly by a 2.5 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

FEATURES

- 2.5 V drive avaliable
- Low on-state resistance $R_{DS(on)1} = 17.5 \text{ m}\Omega \text{ MAX}. (V_{GS} = 4.5 \text{ V}, \text{ ID} = 4.0 \text{ A})$ $R_{DS(on)2} = 18.5 \text{ m}\Omega \text{ MAX}. (V_{GS} = 4.0 \text{ V}, \text{ ID} = 4.0 \text{ A})$ $R_{DS(on)3} = 22.0 \text{ m}\Omega \text{ MAX}. (V_{GS} = 3.1 \text{ V}, \text{ ID} = 4.0 \text{ A})$ $R_{DS(on)4} = 27.5 \text{ m}\Omega \text{ MAX}. (V_{GS} = 2.5 \text{ V}, \text{ ID} = 4.0 \text{ A})$
- Built-in G-S protection diode against ESD

ORDERING INFORMATION

PART NUMBER	PACKAGE	
μ PA2450TL	6PIN HWSON (4521)	

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

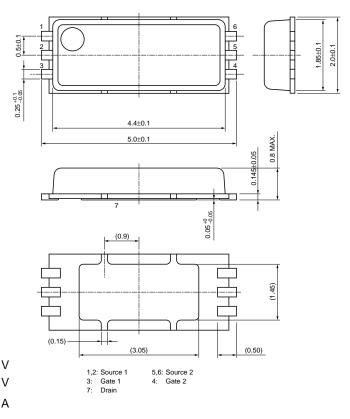
Drain to Source Voltage (Vgs = 0 V)	VDSS	20	V
Gate to Source Voltage (VDs = 0 V)	Vgss	±12	V
Drain Current (DC) (T _A = 25°C)	ID(DC)	±8.6	А
Drain Current (pulse) Note1	D(pulse)	±80	А
Total Power Dissipation (2 unit) Note2	P _{T1}	2.5	W
Total Power Dissipation (2 unit) Note3	P _{T2}	0.7	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

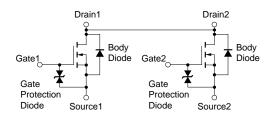
- **2.** $T_A = 25^{\circ}C$ Mounted on ceramic board.
- **3.** $T_A = 25^{\circ}C$ Mounted on FR4 board.
- **Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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PACKAGE DRAWING (Unit: mm)



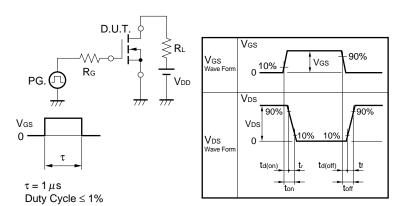
EQUIVALENT CIRCUIT



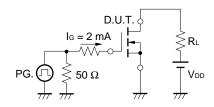
ELECTRICAL CHARACTERISTICS (TA = 25°C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 20 V, V_{GS} = 0 V$			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 12 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1.0 mA	0.5	1.0	1.5	V
Forward Transfer Admittance	y _{fs}	Vds = 10 V, Id = 4.0 A	5.0			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = 4.5 V, Id = 4.0 A	11	14	17.5	mΩ
	RDS(on)2	Vgs = 4.0 V, Id = 4.0 A	11.5	14.5	18.5	mΩ
	RDS(on)3	Vgs = 3.1 V, Id = 4.0 A	12.0	16.5	22.0	mΩ
	RDS(on)4	Vgs = 2.5 V, Id = 4.0 A	15.3	20.5	27.5	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		540		pF
Output Capacitance	Coss	Vgs = 0 V		200		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		120		pF
Turn-on Delay Time	td(on)	$V_{DD} = 10 \text{ V}, \text{ Id} = 4.0 \text{ A}$		40		ns
Rise Time	tr	V _{GS} = 4.0 V		160		ns
Turn-off Delay Time	td(off)	Rg = 6.0 Ω		190		ns
Fall Time	tr			200		ns
Total Gate Charge	Q _G	Vdd = 16 V		9.0		nC
Gate to Source Charge	QGS	Vgs = 4.0 V		1.5		nC
Gate to Drain Charge	Qgd	ID = 8.6 A		4.5		nC
Body Diode Forward Voltage	VF(S-D)	IF = 8.6 A, VGS = 0 V		0.83		V
Reverse Recovery Time	trr	IF = 8.6 A, VGS = 0 V		300		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		760		nC

TEST CIRCUIT 1 SWITCHING TIME

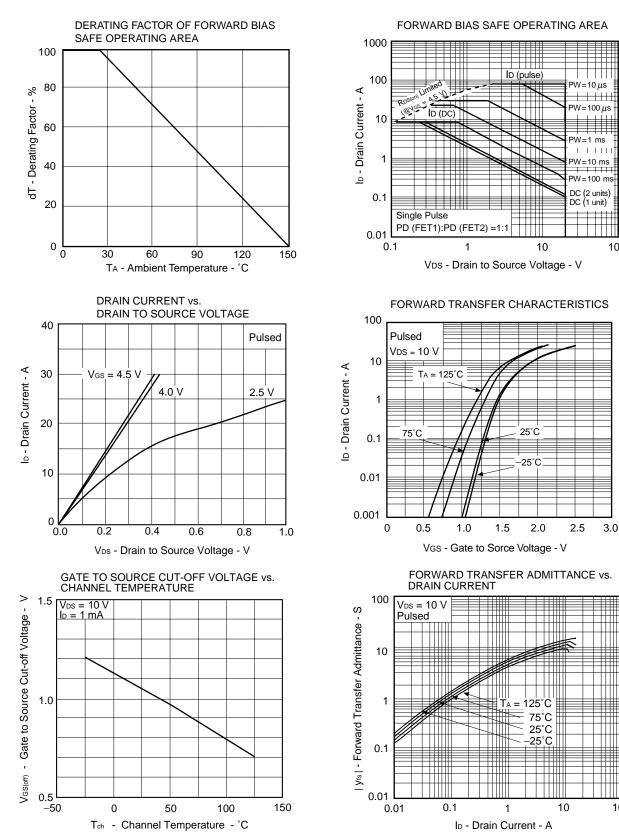


TEST CIRCUIT 2 GATE CHARGE



100

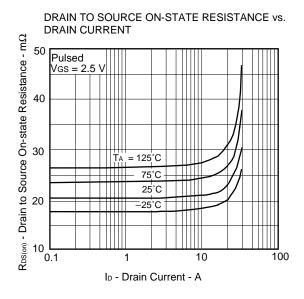


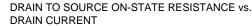


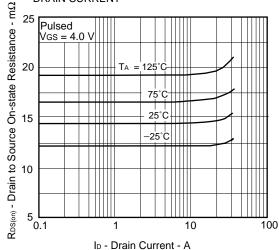
Data Sheet G15612EJ1V0DS

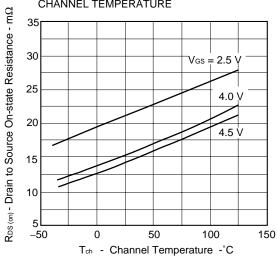
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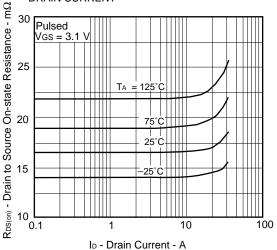




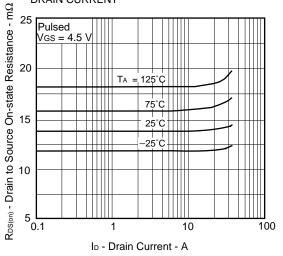


DRAIN TO SOURCE ON - STATE RESISTANCE vs. CHANNEL TEMPERATURE

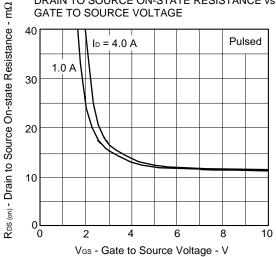
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

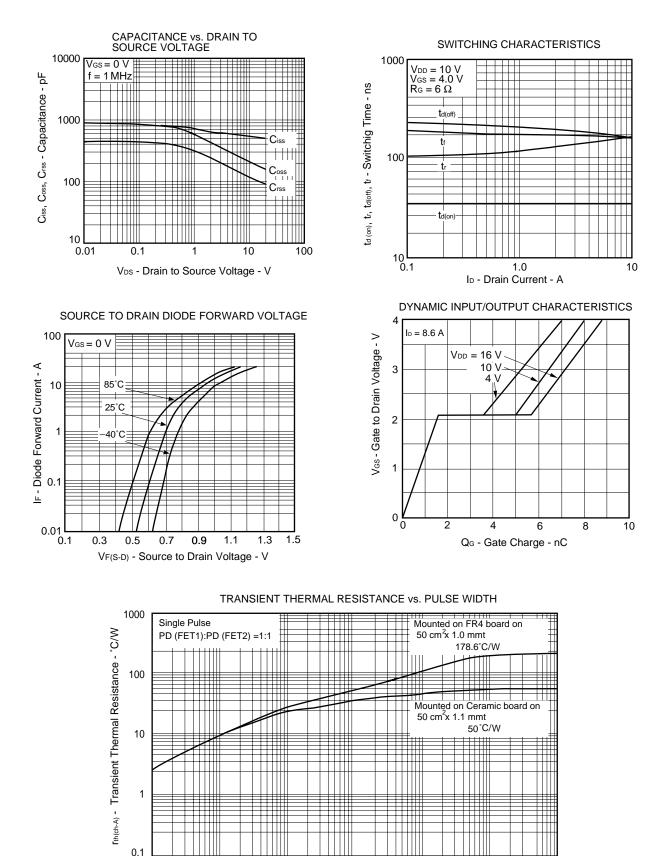


DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE





Data Sheet G15612EJ1V0DS

1

PW - Pulse Width - s

10

100

1000

0.1

0.001

0.01

[MEMO]

[MEMO]

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